

TLE8261-2E Information



For Reference Only

Part Number TLE8261-2E

Manufacturer Infineon Technologies

Category Integrated Circuits (ICs)

Specialized ICs

Description IC SYSTEM BASIS CHIP DSO-36

Package 36-BSSOP (0.295", 7.50mm Width) Exposed Pad

For the pricing/inventory/lead time, please contact

us

Website: https://www.heisener.com E-mail: salesdept@heisener.com



Request a Quote

Certified Quality

Heisener's commitment to quality has shaped our processes for sourcing, testing, shipping, and every step in between. This foundation underlies each component we sell.









TLE8261-2E Specifications

Manufacturer Part Number	TLE8261-2E
Manufacturer	Infineon Technologies
Category	Integrated Circuits (ICs)
	Specialized ICs
Package	36-BSSOP (0.295", 7.50mm Width) Exposed Pad
Series	-
Туре	Transceiver
Applications	Automotive
Mounting Type	Surface Mount
Package / Case	36-BSSOP (0.295", 7.50mm Width) Exposed Pad
Supplier Device Package	PG-DSO-36
	Report errors?

TLE8261-2E Guarantees



Quality Guarantees

We provide 90 days warranty. *

If the items you received were not in perfect quality, we would be responsible for your refund or replacement, but the items must be returned in their original condition.



Service Guarantees

We guarantee 100% customer satisfaction.

Our experienced sales team and tech support team back our services to satisfy all our customers.

TLE8261-2E Payment Methods



















TLE8261-2E Shipping Methods













If you have any question about TLE8261-2E, please do not hesitate to contact us!

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